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Dear Customer,

On 7 February 2017 the former NXP Standard Product business became a new company with the tradename **Nexperia**. Nexperia is an industry leading supplier of Discrete, Logic and PowerMOS semiconductors with its focus on the automotive, industrial, computing, consumer and wearable application markets

In data sheets and application notes which still contain NXP or Philips Semiconductors references, use the references to Nexperia, as shown below.

Instead of <a href="http://www.nxp.com">http://www.nxp.com</a>, <a href="http://www.semiconductors.philips.com/">http://www.nxp.com</a>, <a href="http://www.nexperia.com">http://www.nexperia.com</a>, <a href="http://www.nexperia.com">http://www.nexperia.com</a>)

Instead of sales.addresses@www.nxp.com or sales.addresses@www.semiconductors.philips.com, use salesaddresses@nexperia.com (email)

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If you have any questions related to the data sheet, please contact our nearest sales office via e-mail or telephone (details via **salesaddresses@nexperia.com**). Thank you for your cooperation and understanding,

Kind regards,

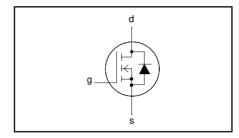
Team Nexperia

**BSH105** 

### **FEATURES**

- · Very low threshold voltage
- · Fast switching
- Logic level compatible
- Subminiature surface mount package

### **SYMBOL**



### **QUICK REFERENCE DATA**

$$V_{DS} = 20 \text{ V}$$
 
$$I_D = 1.05 \text{ A}$$
 
$$R_{DS(ON)} \le 250 \text{ m}\Omega \text{ (V}_{GS} = 2.5 \text{ V)}$$
 
$$V_{GS(TO)} \ge 0.4 \text{ V}$$

### **GENERAL DESCRIPTION**

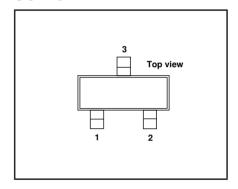
N-channel, enhancement mode, logic level, field-effect power transistor. This device has very low threshold voltage and extremely fast switching making it ideal for battery powered applications and high speed digital interfacing.

The BSH105 is supplied in the SOT23 subminiature surface mounting package.

#### **PINNING**

PIN	DESCRIPTION	
1	gate	
2	source	
3	drain	

#### SOT23



### **LIMITING VALUES**

Limiting values in accordance with the Absolute Maximum System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V <sub>DS</sub>	Drain-source voltage		-	20	V
$V_{DGR}$	Drain-gate voltage	$R_{GS} = 20 \text{ k}\Omega$	-	20	V
V <sub>GS</sub>	Gate-source voltage		-	± 8	V
I <sub>D</sub>	Drain current (DC)	$T_a = 25 ^{\circ}C$	-	1.05	Α
	, ,	$T_a = 100 ^{\circ}C$	-	0.67	Α
I <sub>DM</sub>	Drain current (pulse peak value)	$T_a = 25  ^{\circ}C$	-	4.2	Α
P <sub>tot</sub>	Total power dissipation	T <sub>a</sub> = 25 °C	-	0.417	W
	'	T <sub>a</sub> = 100 °C	-	0.17	W
$T_{stg},T_{i}$	Storage & operating temperature		- 55	150	°C

### THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
R <sub>th j-a</sub>	Thermal resistance junction to ambient	FR4 board, minimum footprint	300	1	K/W

Philips Semiconductors Product specification

# N-channel enhancement mode MOS transistor

**BSH105** 

## **ELECTRICAL CHARACTERISTICS**

 $T_{i}$ = 25°C unless otherwise specified

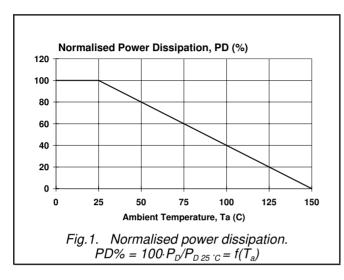
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}; I_D = 10 \mu\text{A}$	20	-	-	V
$V_{GS(TO)}$	Gate threshold voltage	$V_{DS} = V_{GS}$ ; $I_D = 1 \text{ mA}$	0.4	0.57	-	V
	Daria da	$T_{j} = 150^{\circ}C$	0.1	-	-	V
$R_{DS(ON)}$	Drain-source on-state resistance	$V_{GS} = 4.5 \text{ V}; I_D = 0.6 \text{ A}$ $V_{GS} = 2.5 \text{ V}; I_D = 0.6 \text{ A}$	-	140 180	200 250	$m\Omega$ $m\Omega$
	Tesistanee	$V_{GS} = 1.8 \text{ V}; I_D = 0.3 \text{ A}$	-	240	300	mΩ
		$V_{GS} = 2.5 \text{ V}; I_D = 0.6 \text{ A}; T_i = 150^{\circ}\text{C}$	-	270	375	mΩ
$g_{fs}$	Forward transconductance	$V_{DS} = 16 \text{ V}; I_{D} = 0.6 \text{ A}$	0.5	1.6	-	S
I <sub>GSS</sub>	Gate source leakage current	$V_{GS} = \pm 8 \text{ V}; V_{DS} = 0 \text{ V}$	-	10	100	nA
I <sub>DSS</sub>	Zero gate voltage drain current	$V_{DS} = 16 \text{ V}; V_{GS} = 0 \text{ V};$ $T_i = 150^{\circ}\text{C}$	-	50 1.3	100 10	nA μA
$Q_{g(tot)}$	Total gate charge	$I_D = 1 \text{ A}; V_{DD} = 20 \text{ V}; V_{GS} = 4.5 \text{ V}$	-	3.9	-	nC
Q <sub>gs</sub>	Gate-source charge	, de	-	0.4	-	nC
$Q_{gd}$	Gate-drain (Miller) charge		-	1.4	-	nC
t <sub>d on</sub>	Turn-on delay time	$V_{DD} = 20 \text{ V}; I_D = 1 \text{ A};$	-	2	-	ns
t <sub>r</sub>	Turn-on rise time	$V_{GS} = 8 \text{ V}; R_G = 6 \Omega$	-	4.5	-	ns
t <sub>d off</sub>	Turn-off delay time	Resistive load	-	45	-	ns
L <sub>f</sub>	Turn-off fall time		-	20	-	ns
C <sub>iss</sub>	Input capacitance	$V_{GS} = 0 \text{ V}; V_{DS} = 16 \text{ V}; f = 1 \text{ MHz}$	-	152	-	pF
C <sub>oss</sub>	Output capacitance Feedback capacitance		-	71 33	_	pF pF
$C_{rss}$	I eedback capacitatice			- 55		μ

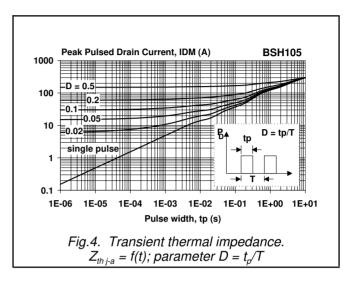
## REVERSE DIODE LIMITING VALUES AND CHARACTERISTICS

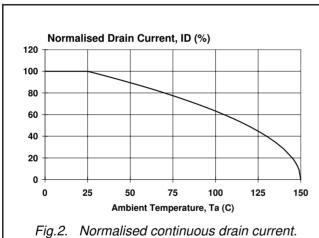
 $T_i = 25^{\circ}C$  unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I <sub>DR</sub>	Continuous reverse drain current	T <sub>a</sub> = 25 °C	-	-	1.05	Α
$oldsymbol{I_{DRM}}{oldsymbol{V_{SD}}}$	Pulsed reverse drain current Diode forward voltage	$I_F = 0.5 \text{ A}; V_{GS} = 0 \text{ V}$		- 0.74	4.2 1	A V
t <sub>rr</sub> Q <sub>rr</sub>	Reverse recovery time Reverse recovery charge	$ \begin{aligned} I_F &= 0.5 \text{ A}; \ \text{-d}I_F/\text{d}t = 100 \text{ A}/\mu\text{s}; \\ V_{GS} &= 0 \text{ V}; \ V_R = 16 \text{ V} \end{aligned} $	-	27 19	-	ns nC

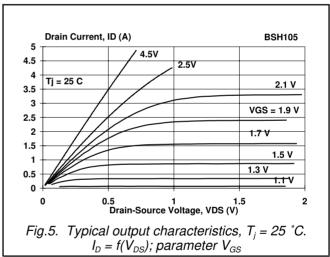
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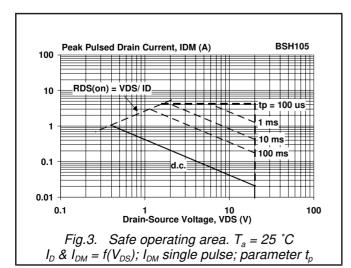


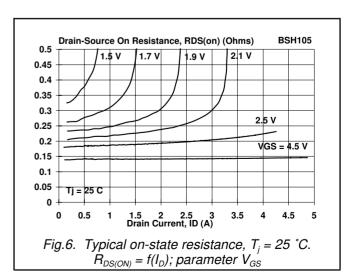




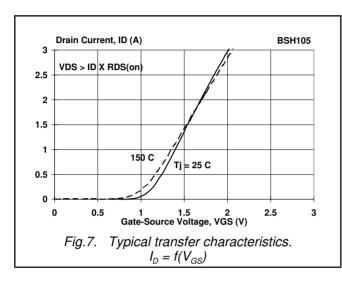
 $ID\% = 100 \cdot I_D/I_{D.25 \cdot C} = f(T_a)$ ; conditions:  $V_{GS} \ge 4.5 \text{ V}$ 

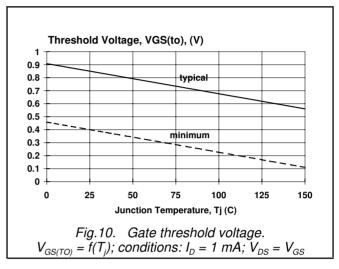


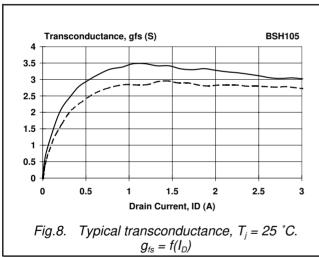


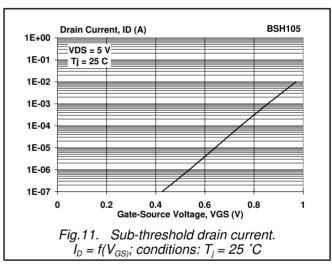


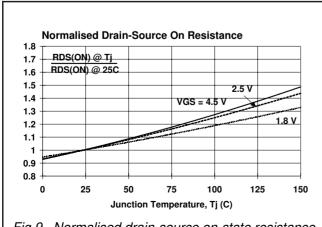
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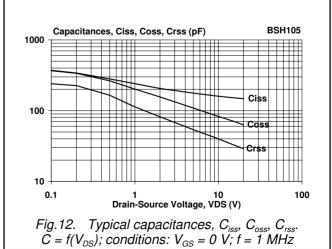
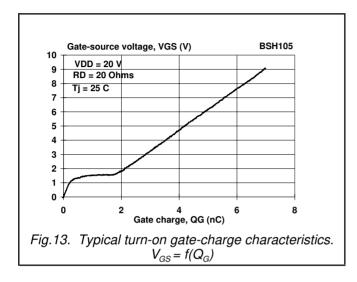
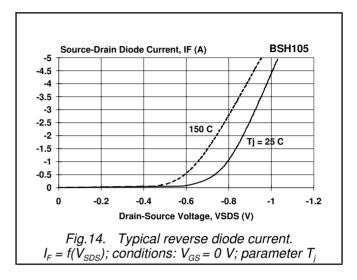


Fig. 9. Normalised drain-source on-state resistance.  $R_{DS(ON)}/R_{DS(ON)25 \cdot C} = f(T_i)$  Fig. 12. Typical capacitances,  $C_{iss}$ ,  $C_{oss}$ ,  $C_r$   $C = f(V_{DS})$ ; conditions:  $V_{GS} = 0$  V; f = 1 MH

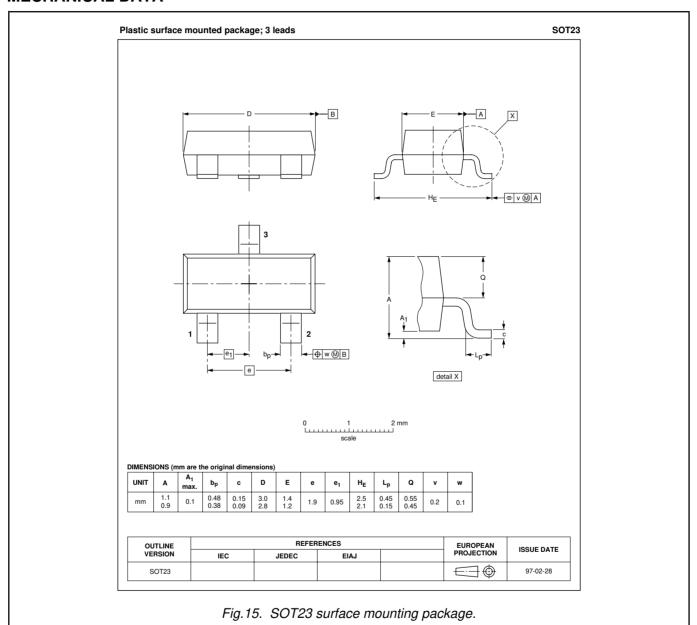
BSH105





**BSH105** 

## **MECHANICAL DATA**



#### **Notes**

- 1. This product is supplied in anti-static packaging. The gate-source input must be protected against static discharge during transport or handling.
- 2. Refer to SMD Footprint Design and Soldering Guidelines, Data Handbook SC18.
- 3. Epoxy meets UL94 V0 at 1/8".

Philips Semiconductors Product specification

## N-channel enhancement mode MOS transistor

**BSH105** 

#### **DEFINITIONS**

Data sheet status				
Objective specification	This data sheet contains target or goal specifications for product development.			
Preliminary specification This data sheet contains preliminary data; supplementary data may be published late				
Product specification This data sheet contains final product specifications.				
Limiting values				

Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

#### **Application information**

Where application information is given, it is advisory and does not form part of the specification.

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